



SamHop Microelectronics Corp.



SP2102

Ver 1.0

## Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
100V	2.0A	216 @ VGS=10V

### FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
$V_{DS}$	Drain-Source Voltage		100	V
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a e</sup>	$T_A=25^\circ\text{C}$	2.0	A
		$T_A=70^\circ\text{C}$	1.6	A
$I_{DM}$	-Pulsed <sup>b</sup>		13	A
$E_{AS}$	Single Pulse Avalanche Energy <sup>d</sup>		16	mJ
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	1.47	W
		$T_A=70^\circ\text{C}$	0.94	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_\theta JA$	Thermal Resistance, Junction-to-Ambient	85	$^\circ\text{C/W}$
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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
Idss	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$			1	$\mu A$
IGSS	Gate-Body Leakage Current	$V_{GS} = \pm 20V, V_{DS}=0V$			$\pm 100$	$nA$
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.7	2.5	V
RDS(ON)	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=1A$		173	216	m ohm
g <sub>FS</sub>	Forward Transconductance	$V_{DS}=10V, I_D=1A$		2		S
<b>DYNAMIC CHARACTERISTICS</b> <sup>c</sup>						
C <sub>ISS</sub>	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		300		pF
C <sub>OSS</sub>	Output Capacitance			35		pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			23		pF
<b>SWITCHING CHARACTERISTICS</b> <sup>c</sup>						
t <sub>D(ON)</sub>	Turn-On Delay Time	$V_{DD}=50V$ $I_D=1A$ $V_{GS}=10V$ R <sub>GEN</sub> = 6 ohm		9		ns
t <sub>r</sub>	Rise Time			9		ns
t <sub>D(OFF)</sub>	Turn-Off Delay Time			17		ns
t <sub>f</sub>	Fall Time			3.8		ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS}=50V, I_D=1A, V_{GS}=10V$		5		nC
		$V_{DS}=50V, I_D=1A, V_{GS}=4.5V$		3		nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}=50V, I_D=1A,$ $V_{GS}=10V$		0.9		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.6		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
V <sub>SD</sub>	Diode Forward Voltage	$V_{GS}=0V, I_S=2A$		0.83	1.2	V
<b>Notes</b>						
a. Surface Mounted on FR4 Board, t < 10sec.						
b. Pulse Test: Pulse Width < 300us, Duty Cycle < 2%.						
c. Guaranteed by design, not subject to production testing.						
d. Starting T <sub>J</sub> =25°C, L=0.5mH, V <sub>DD</sub> = 50V. (See Figure13)						
e. Drain current limited by maximum junction temperature.						

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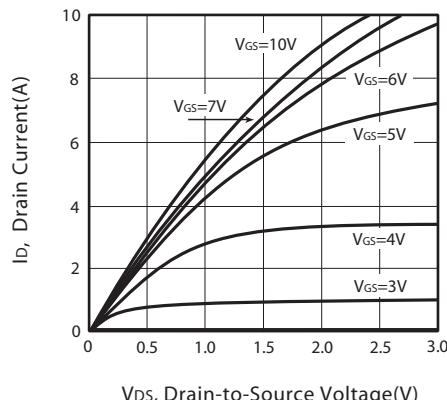


Figure 1. Output Characteristics

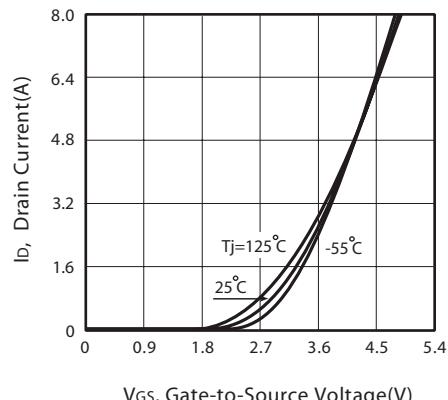


Figure 2. Transfer Characteristics

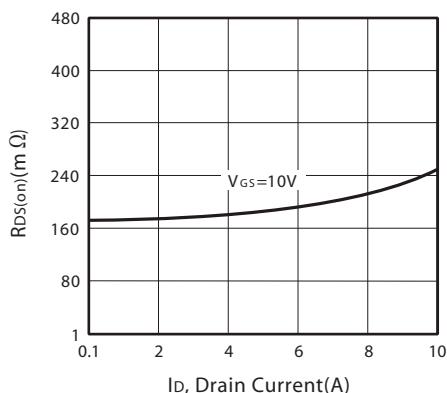


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

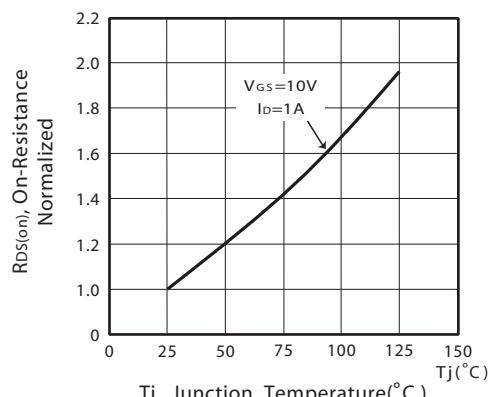


Figure 4. On-Resistance Variation with Drain Current and Temperature

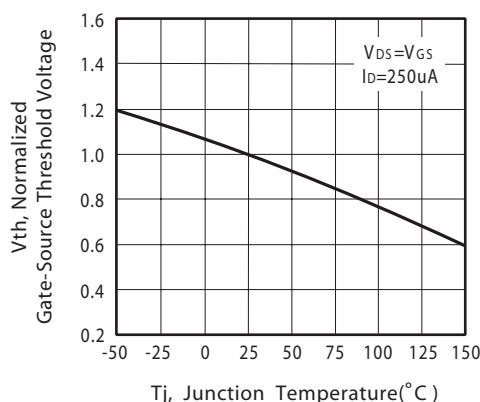


Figure 5. Gate Threshold Variation with Temperature

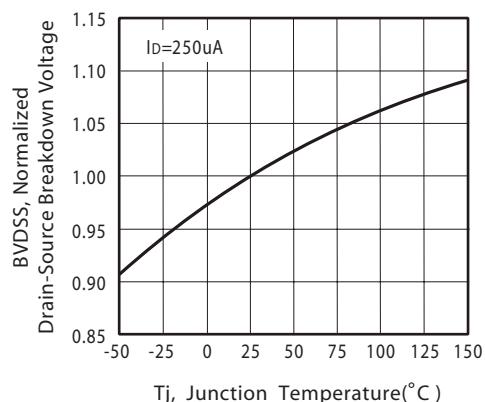
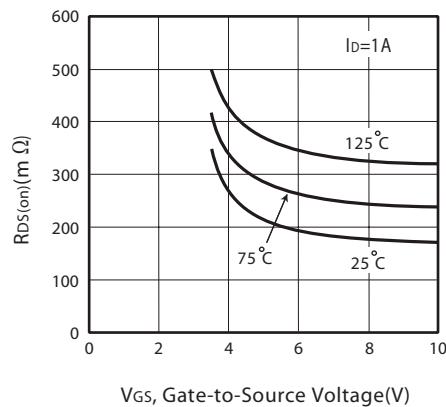


Figure 6. Breakdown Voltage Variation with Temperature

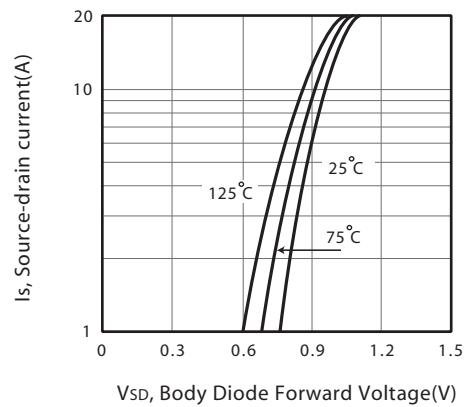
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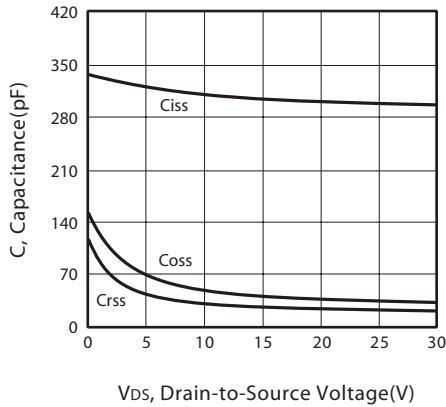
V<sub>GS</sub>, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



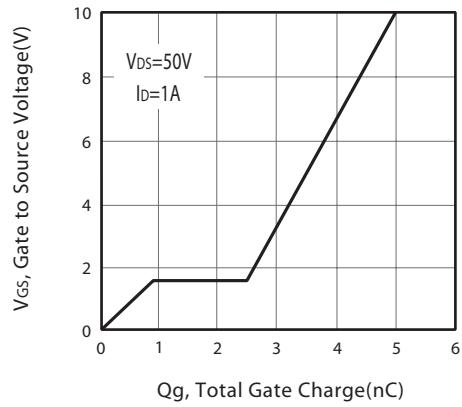
V<sub>SD</sub>, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



V<sub>DS</sub>, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q<sub>g</sub>, Total Gate Charge(nC)

Figure 10. Gate Charge

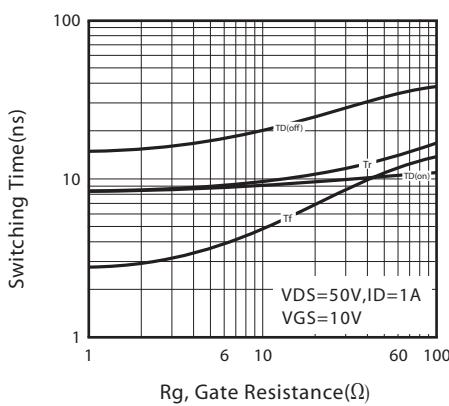


Figure 11. switching characteristics

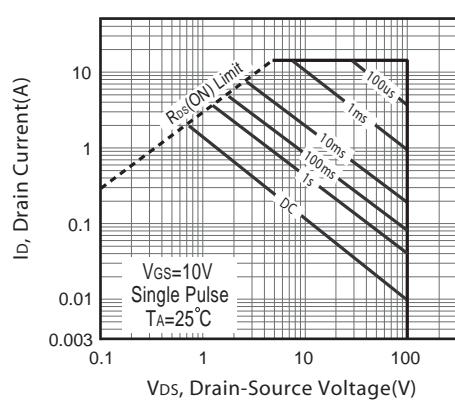
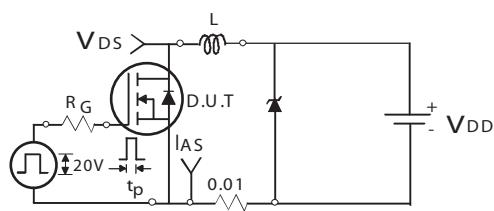


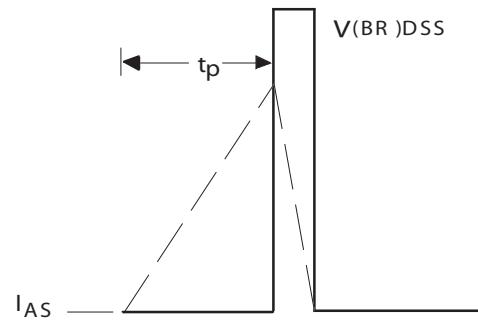
Figure 12. Maximum Safe Operating Area

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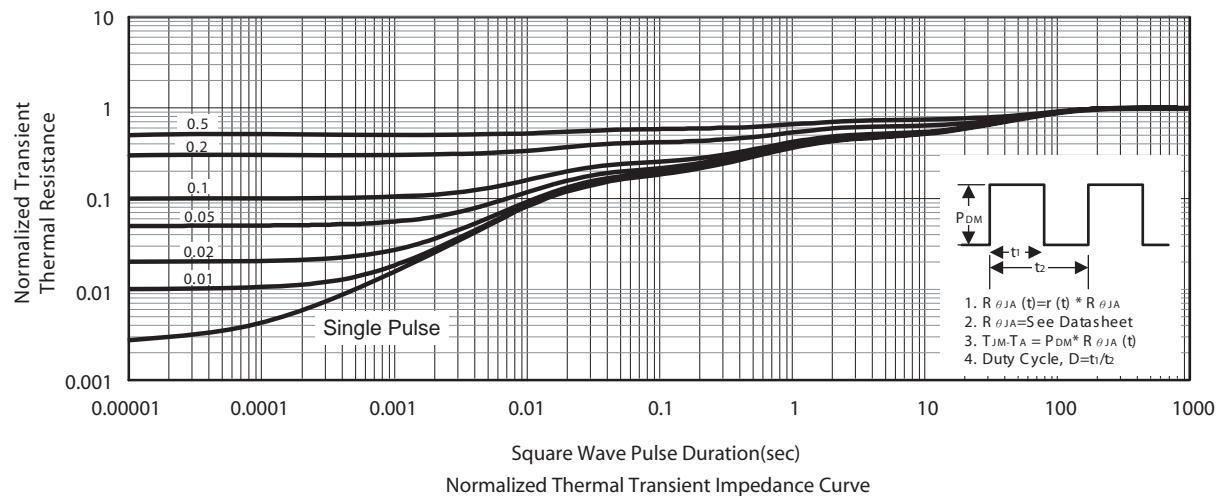
Unclamped Inductive Test Circuit

Figure 13a.



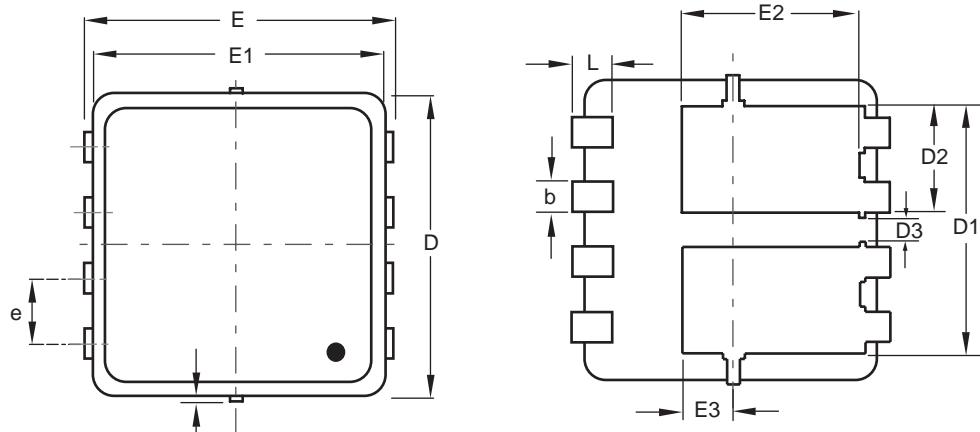
Unclamped Inductive Waveforms

Figure 13b.



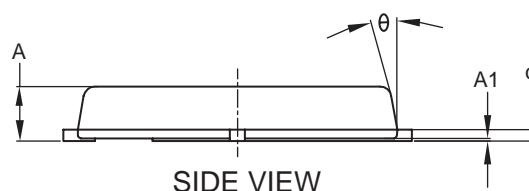
## PACKAGE OUTLINE DIMENSIONS

**DFN 3x3-8L**



TOP VIEW

BOTTOM VIEW



SIDE VIEW

SYMBOLS	MILLIMETERS		
	MIN	NOM	MAX
A	0.70	0.80	0.90
A1	0.00	—	0.05
b	0.24	0.30	0.35
c	0.10	0.152	0.25
D	3.00 BSC		
D1	2.475 BSC		
D2	1.063 BSC		
D3	0.225 BSC		
E	3.20 BSC		
E1	3.00 BSC		
E2	1.813 BSC		
E3	0.525 BSC		
e	0.65 BSC		
L	0.30	0.40	0.50
L1	0.00	—	0.100
θ	0°	10°	12°

## TOP MARKING DEFINITION

DFN 3x3

